Docket No.:		
<u>DECLAR</u>	ATION AND POWER	OF ATTORNEY
As a below named inventor, I her	eby declare that:	
My residence, post office and citiz	zenship are as stated below next to my	name,
inventor (if plural names are liste	ed below) of the subject matter claim	s listed below) or an original, first and join ed and for which a patent is sought on the, the specification of which
		plication Serial No and was
	(if applicabl	
	ed and understand the contents of the	above identified specification, including the
I acknowledge the duty to discloswith Title 37, Code of Federal Re	se information which is known to me gulations, Section 1.56(a).	to be material to patentability in accordance
than the United States of America	of any PCT international application values and have also identified secretificate, or of any PCT internation	5 (b) of any foreign application(s) for patent which designated at least one country other below, by checking the box, any foreign hal application having a filing date before
Prior Foreign Application(s): Number	Country	Foreign Filing Date <u>Month/Day/Year</u>
74389/2003	Korea	10/23/2003
I hereby claim the benefit under 3	35 U.S.C. 119(e) of any United States p	rovisional application(s) listed below.
Application Number(s):	Filing Date	(Month/Day/Year)
international application designation of the claims of this application manner provided by the first is material to patentability as defi	ng the United States of America, listed tion is not disclosed in the prior Unite paragraph of 35 U.S.C. 112, I acknowl	ates application(s), or 365(c) of any PC7 d below and, insofar as the subject matter of a states or PCT international application in ledge the duty to disclose information which vailable between the filing date of the priorication.
Prior U. S. Application or PCT Parent Number	Filing Date (Month/Day/Year)	Parent Patent Number (if applicable)
PCT/KR2004/002378	September 16, 2004	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s) associated with Customer Number 34610 with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. <u>Direct all correspondence to Customer Number 34610</u>.

**************************************	****
Full name of sole or first inventor: Yoon-Seob EOM	
Inventor's signature: Date: 3006.3.	20.
Mailing Address: Woosung Apt. 101-2508, Namyang ting, Changwon, Gyungsangnam-Do, Korea	
Citizenship: Republic of Korea	
Residence Address	
(only if different from mailing address):	
**************************************	****
Full name of joint inventor(s): Jeong-Hwan KOO	
Inventor's signature: Date: 2006. 3.	-A
Mailing Address: 18/4, 1346-22, Daeyeon 5-Dong, Nam-Gu, Busan, Korea	
Citizenship:	
Residence Address	
(only if different from mailing address):	
**************************************	***
Full name of joint inventor(s): Nae-Hyun PARK	
Inventor's signature: By WEI Date: 2016. 3. 2	č E
Mailing Address: 17-346, Bulgwang 1-Dong, Eunpyeong-Gu, Seoul, Korea	
Citizenship:	
Residence Address	
(only if different from mailing address):	
*************************	***
Full name of joint inventor(s):  Dong-Joo HAN	
Inventor's signature: Date: 2001 3 .:	2d .
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea	ZeP
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:	28.
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address	28.
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address  (only if different from mailing address):	
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address  (only if different from mailing address):  **********************************	
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	****
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address  (only if different from mailing address):  **********************************	****
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address  (only if different from mailing address):  **********************************	*** 28 rea
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	*** 28 rea
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	*** 28 rea
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	*** 28 rea
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	*** 28 rea
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	*** 28 rea
Inventor's signature:  Mailing Address: 944-3, Dongsam 2-Dong, Yeongdo-Gu, Busan, Korea  Citizenship:  Residence Address (only if different from mailing address):  **********************************	*** 22 rea

**.** 

100

÷